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Siliup Semiconductor

SP010N03BGHTQ

100V N-Channel Power MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	I _D
100V	3.3mΩ@10V	170A

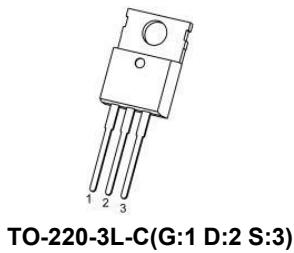
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

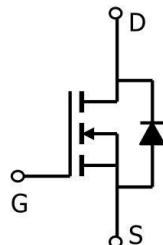
Applications

- Power switching application
- DC-DC Converter
- Power Management

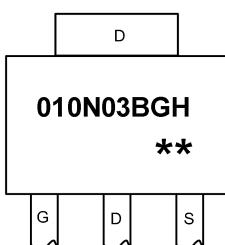
Package



Circuit diagram



Marking



010N03BGH : Product code
** : Week code



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Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain source voltage	V _{DS}	100	V
Gate source voltage	V _{GS}	±20	V
Continuous drain current(Tc=25°C)	I _D	170	A
Pulsed drain current	I _{DM}	680	A
Power dissipation(Tc=25°C)	P _D	250	W
Single pulsed avalanche energy ¹⁾	E _{AS}	180	mJ
Thermal resistance, junction-case	R _{θJC}	0.5	°C/W
Operation and storage temperature	T _{stg} , T _j	-55 to 150	°C

Electrical characteristics (Ta=25°C, unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	100	-	-	V
Drain Cut-Off Current	I _{DSS}	V _{DS} = 80V, V _{GS} = 0V	-	-	1	μA
Gate Leakage Current	I _{GSS}		-	-	±0.1	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.0	2.7	4.0	V
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 30A	-	3.3	4.2	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = 50V, V _{GS} = 0V, f = 1.0MHz	-	4660	-	pF
Output Capacitance	C _{oss}		-	1208	-	
Reverse Transfer Capacitance	C _{rss}		-	28	-	
Switching Characteristics						
Total Gate Charge	Q _g	V _{DS} =50V , V _{GS} =10V , ID=20A	-	79	-	nC
Gate-Source Charge	Q _{gs}		-	12	-	
Gate-Drain Charge	Q _{gd}		-	25	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 50V, RL=2.5Ω , R _G = 6.0Ω	-	12	-	ns
Rise Time	t _r		-	23	-	
Turn-Off Delay Time	t _{d(off)}		-	85	-	
Fall Time	t _f		-	62	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1.2	V

Note:

- E_{AS} is tested at starting T_j = 25°C, V_{DD}=50V,V_{GS} = 10V,L = 0.1mH,R_g=25mΩ;



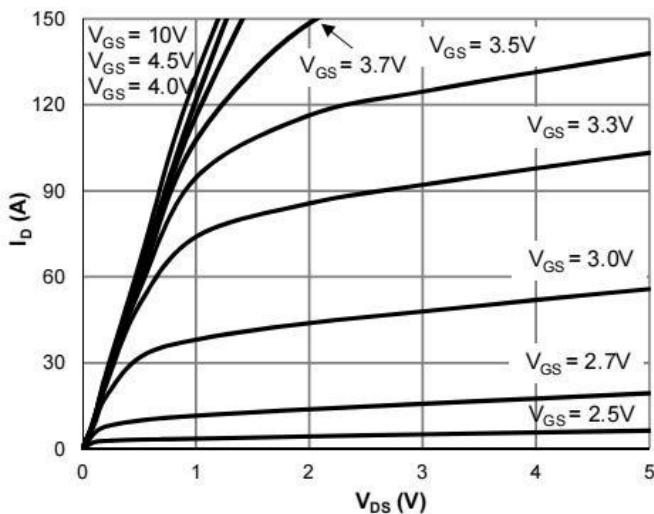
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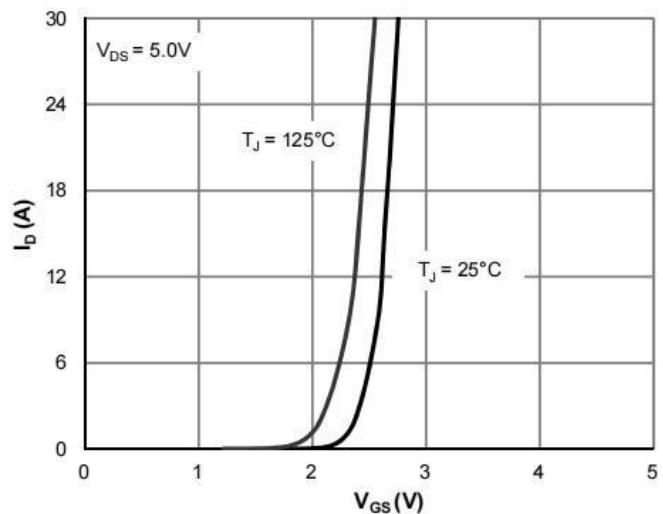
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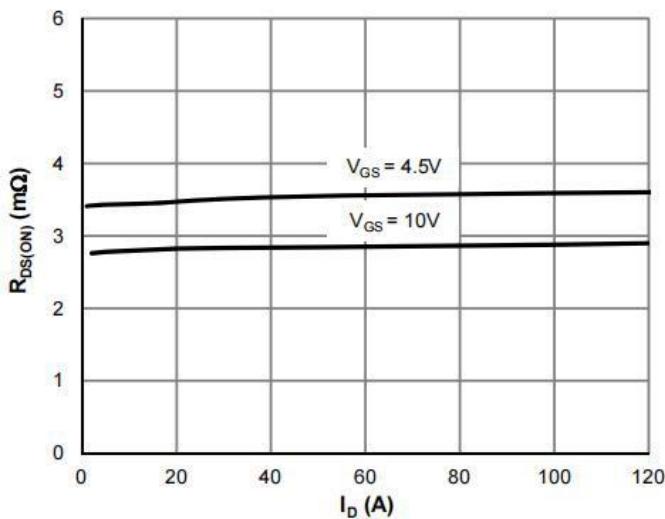
Typical Characteristics



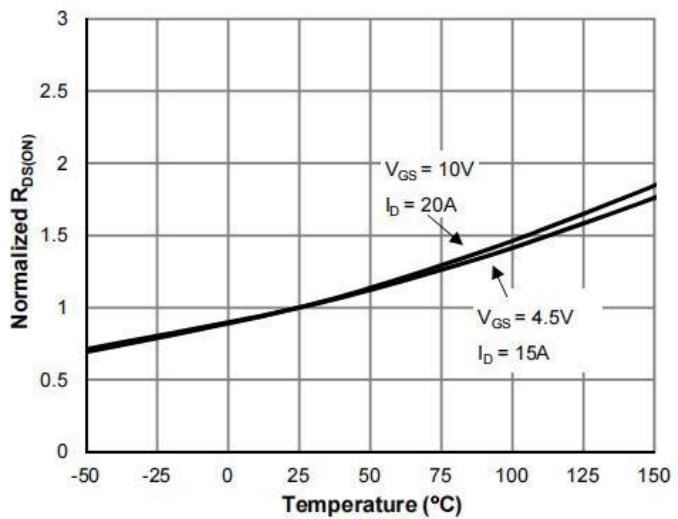
Typical Output Characteristics



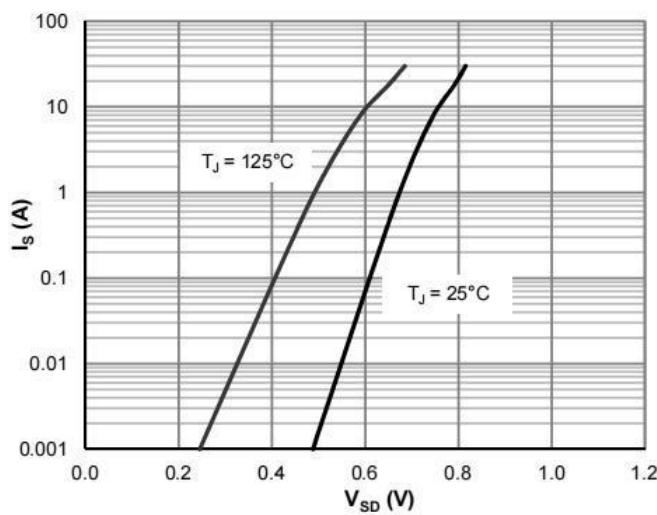
Transfer Characteristics



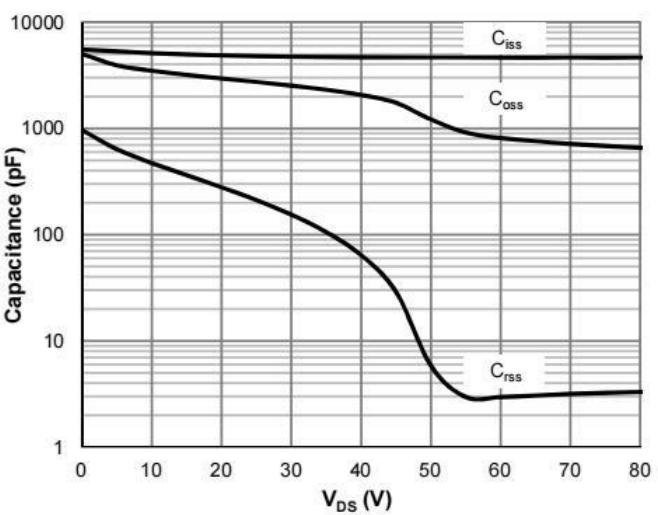
On-Resistance vs. Drain Current



On-Resistance vs. Junction Temperature



Body-Diode Characteristics



Capacitance Characteristics

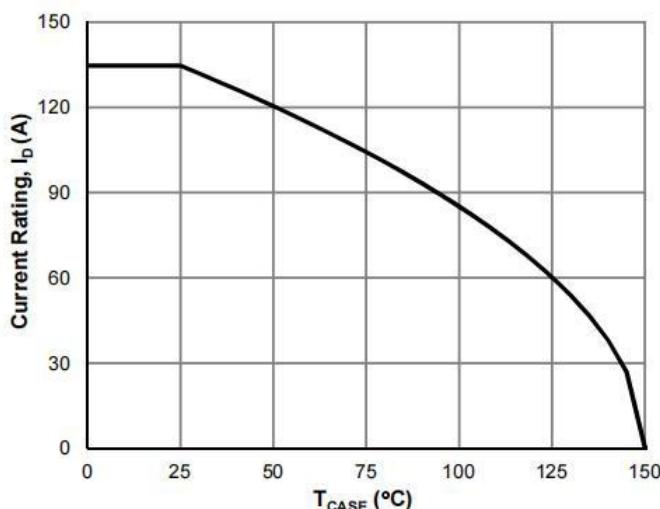


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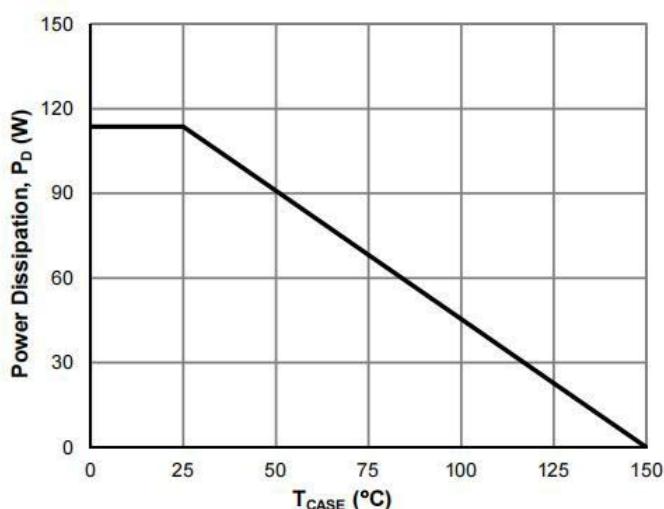
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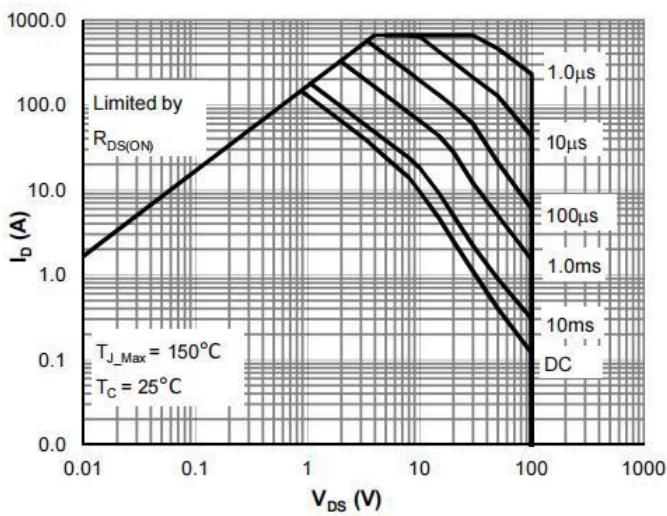
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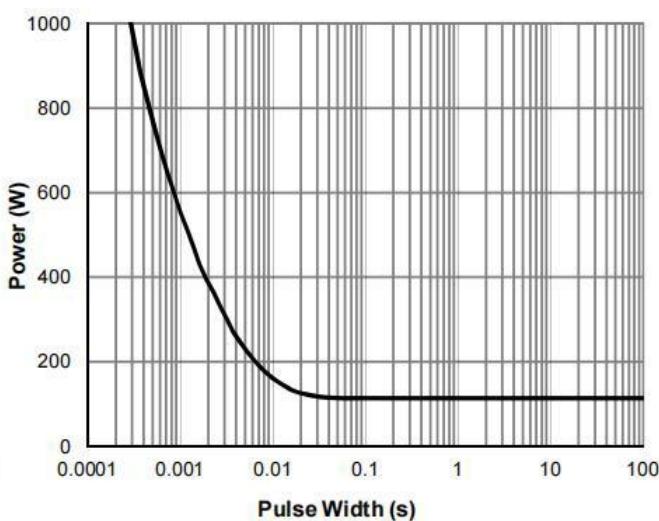
Current De-rating



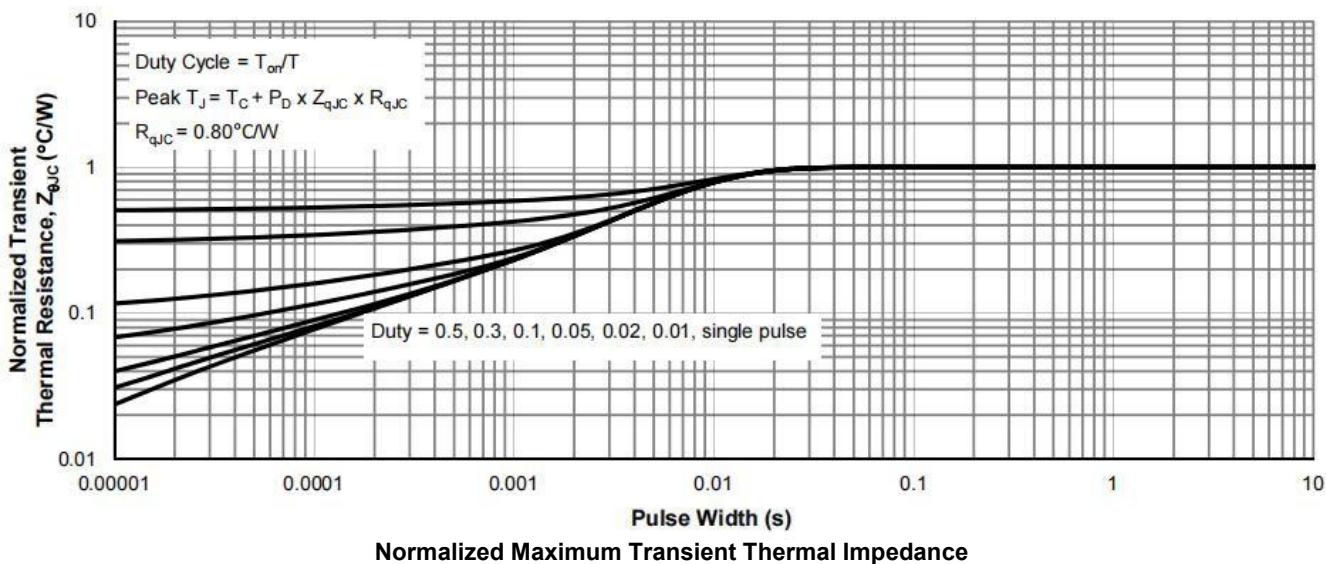
Power De-rating



Maximum Safe Operating Area



Single Pulse Power Rating, Junction-to-Case





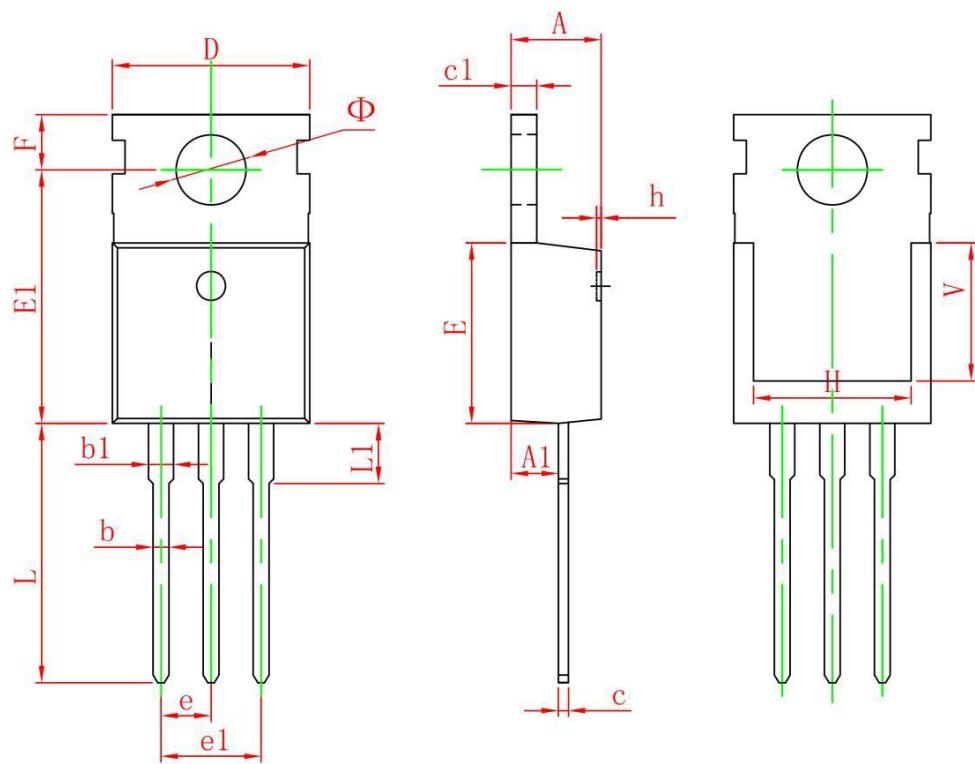
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TO-220-3L-C Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900 REF.		0.276 REF.	
Φ	3.400	3.800	0.134	0.150